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# MULTIPLE (QUAD) NPN SILICON DUAL IN-LINE AND FLATPACK SWITCHING TRANSISTOR <br> Qualified per MIL-PRF-19500/559 

## DEVICES

2N6989 2N6989U
2N6990

## LEVELS

JAN
JANTX JANTXV JANS

ABSOLUTE MAXIMUM RATINGS $\left(T_{C}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameters / Test Conditions | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Collector-Emitter Voltage ${ }^{(3)}$ | $\mathrm{V}_{\mathrm{CEO}}$ | 50 | Vdc |
| Collector-Base Voltage ${ }^{(3)}$ | $\mathrm{V}_{\mathrm{CBO}}$ | 75 | Vdc |
| Emitter-Base Voltage $^{(3)}$ | $\mathrm{V}_{\mathrm{EBO}}$ | 6.0 | Vdc |
| Collector Current ${ }^{(3)}$ | $\mathrm{I}_{\mathrm{C}}$ | 800 | mAdc |
| Total Power Dissipation | $\mathrm{P}_{\mathrm{D}}$ | 1.5 <br> 1.0 <br> $\mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | W |
| Operating \& Storage Junction Temperature Range | $\mathrm{T}_{\mathrm{op}}, \mathrm{T}_{\text {stg }}$ | -65 to +200 | ${ }^{\circ} \mathrm{C}$ |

## Note:

1. Maximum voltage between transistors shall be $\geq 500 \mathrm{Vdc}$.
2. For derating, see figures $6,7,8$ and 9. Ratings apply to total package.
3. For thermal impedance curves, see figures $10,11,12$ and 13.
4. Ratings apply to each transistor in the array.

ELECTRICAL CHARACTERISTICS $\left(T_{A}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted)

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERTICS |  |  |  |  |  |  |  |  |
| Collector-Emitter Breakdown Voltage <br> $\mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}$ | $\mathrm{V}_{(\mathrm{BR}) \mathrm{CEO}}$ | 50 |  | Vdc |  |  |  |  |
| Collector-Base Cutoff Current |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CB}}=60 \mathrm{Vdc}$ | $\mathrm{I}_{\mathrm{CBO}}$ |  | 10 | $\eta \mathrm{Adc}$ |  |  |  |  |
| $\mathrm{V}_{\mathrm{CB}}=75 \mathrm{Vdc}$ |  | 10 | $\mu \mathrm{Adc}$ |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CB}}=60 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=+150^{\circ} \mathrm{C}$ |  |  | 10 | $\mu \mathrm{Adc}$ |  |  |  |  |
| Emitter-Base Cutoff Current |  |  | 10 | $\mu \mathrm{Adc}$ |  |  |  |  |
| $\mathrm{V}_{\mathrm{EB}}=4.0 \mathrm{Vdc}$ | $\mathrm{I}_{\mathrm{EBO}}$ |  | 10 | $\eta \mathrm{Adc}$ |  |  |  |  |
| $\mathrm{V}_{\mathrm{EB}}=6.0 \mathrm{Vdc}$ |  |  |  |  |  |  |  |  |



TO-116 - 2N6989


20 PIN LEADLESS 2N6989U


14 PIN FLAT PACK 2N6990

## ELECTRICAL CHARACTERISTICS ( $\boldsymbol{T}_{A}=+25^{\circ} \mathrm{C}$, unless otherwise noted)

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: |
| ON CHARACTERISTICS ${ }^{(4)}$ |  |  |  |  |
| $\begin{aligned} & \text { Forward-Current Transfer Ratio } \\ & \mathrm{I}_{\mathrm{C}}=0.1 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc} \\ & \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc} \\ & \mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc} \\ & \mathrm{I}_{\mathrm{C}}=150 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc} \\ & \mathrm{I}_{\mathrm{C}}=500 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc} \\ & \mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{~T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \end{aligned}$ | $\mathrm{h}_{\text {FE }}$ | $\begin{gathered} 50 \\ 75 \\ 100 \\ 100 \\ 30 \\ 35 \end{gathered}$ | $\begin{aligned} & 325 \\ & 300 \end{aligned}$ |  |
| $\begin{aligned} & \text { Collector-Emitter Saturation Voltage } \\ & \mathrm{I}_{\mathrm{C}}=150 \mathrm{mAdc}, \mathrm{I}_{\mathrm{B}}=15 \mathrm{mAdc} \\ & \mathrm{I}_{\mathrm{C}}=500 \mathrm{mAdc}, \mathrm{I}_{\mathrm{B}}=50 \mathrm{mAdc} \end{aligned}$ | $\mathrm{V}_{\text {CE(sat) }}$ |  | $\begin{aligned} & 0.3 \\ & 1.0 \end{aligned}$ | Vdc |
| Base-Emitter Saturation Voltage <br> $\mathrm{I}_{\mathrm{C}}=150 \mathrm{mAdc}, \mathrm{I}_{\mathrm{B}}=15 \mathrm{mAdc}$ <br> $\mathrm{I}_{\mathrm{C}}=500 \mathrm{mAdc}, \mathrm{I}_{\mathrm{B}}=50 \mathrm{mAdc}$ | $\mathrm{V}_{\text {BE(sat) }}$ | 0.6 | $\begin{aligned} & 1.2 \\ & 2.0 \end{aligned}$ | Vdc |

## DYNAMIC CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Magnitude of Small-Signal Short-Circuit Forward Current Transfer Ratio <br> $\mathrm{I}_{\mathrm{C}}=20 \mathrm{mAdc}, \mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{f}=100 \mathrm{MHz}$ | $\mid \mathrm{h}_{\mathrm{fe}}$ | 2.5 | 8.0 |  |
| Forward current Transfer Ratio <br> $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{mAdc}, \mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{f}=1.0 \mathrm{kHz}$ | $\mathrm{h}_{\mathrm{fe}}$ | 50 |  |  |
| Output Capacitance <br> $\mathrm{V}_{\mathrm{CB}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0,100 \mathrm{kHz} \leq \mathrm{f} \leq 1.0 \mathrm{MHz}$ | $\mathrm{C}_{\mathrm{obo}}$ |  | 8.0 | pF |
| Input Capacitance <br> $\mathrm{V}_{\mathrm{EB}}=0.5 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0,100 \mathrm{kHz} \leq \mathrm{f} \leq 1.0 \mathrm{MHz}$ | $\mathrm{C}_{\mathrm{ibo}}$ |  | 25 | pF |

## SWITCHING CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Turn-On Time <br> SEE FIGURE $14 /$ MIL-PRF-19500/559 | $\mathrm{t}_{\mathrm{on}}$ |  |  |  |
| Turn-Off Time <br> SEE FIGURE 15 / MIL-PRF-19500/559 | $\mathrm{t}_{\mathrm{off}}$ |  | 35 | $\eta \mathrm{~s}$ |

(4) Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $\leq 2.0 \%$.

## PACKAGE DIMENSIONS



| Symbol | Dimensions |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Inches |  | Millimeters |  |  |
|  | Min | Max | Min | Max |  |
| BH |  | .200 |  | 5.08 |  |
| LW | .014 | .023 | 0.36 | 0.58 | 10 |
| LW $_{1}$ | .030 | .070 | 0.76 | 1.78 | 4,10 |
| LT | .008 | .015 | 0.20 | 0.38 | 10 |
| BL |  | .785 |  | 19.94 | 6 |
| BW | .220 | .310 | 5.59 | 7.87 | 6 |
| BW $_{1}$ | .290 | .320 | 7.37 | 8.13 | 9 |


| Symbol | Dimensions |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Inches |  | Millimeters |  |  |
|  | Min | Max | Min |  |  |
|  |  |  |  |  |  |
| LS | .100 BSC |  | 2.54 BSC |  | 7,11 |
| LL | .125 | .200 | 3.18 | 5.08 |  |
| $\mathrm{LL}_{1}$ | .150 |  | 3.81 |  |  |
| LO | .005 |  | 0.13 |  | 8 |
| $\mathrm{LO}_{1}$ |  | .098 |  | 2.49 | 8 |
| $\mathrm{LO}_{2}$ | .015 | .060 | 0.38 | 1.52 | 5 |
| $\alpha$ | $0^{\circ}$ | $15^{\circ}$ | $0^{\circ}$ | $15^{\circ}$ |  |

## NOTES:

1 Dimension are in inches.
2 Millimeters are given for general information only.
3 Index area: A notch or pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
4 The minimum limit for dimension $\mathrm{LW}_{1}$ may be .023 inch ( 0.58 mm ) for leads number $1,7,8$ and 14 only.
5 Dimension $\mathrm{LO}_{2}$ shall be measured from the seating plane to the base plane.
6 This dimension allows for off-center lid, meniscus, and glass overrun.
7 The basic pin spacing is .100 inch $(2.54 \mathrm{~mm})$ between centerlines. Each pin centerline shall be located within $\pm .010$ inch ( 0.25 mm ) of its exact longitudinal position relative to pins 1 and 14.
8 Applies to all four corners (leads number 1, 7, 8 and 14).
9 Lead center when $\alpha$ is 0 degrees. $\mathrm{BW}_{1}$ shall be measured at the centerline of the leads.
10 All leads.
11 Twelve spaces.
12 No organic or polymeric materials shall be molded to the bottom of the package to cover the leads.
13 In accordance with ASME Y14.5M, diameters are equivalent to $\phi x$ symbology.

FIGURE 1. Physical Dimension and Configuration for type 2N6989

## PACKAGE DIMENSIONS



| Symbol | Dimensions |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Inches |  | Millimeters |  |  |
|  | Min | Max | Min | Max |  |
| CH | .030 | .115 | 0.76 | 2.92 |  |
| LW | .010 | .019 | 0.25 | 0.48 | 7 |
| TL | .008 | .015 | 0.20 | 0.38 | 12 |
| BL |  | .280 |  | 7.11 | 5 |
| BW | .240 | .260 | 6.10 | 6.60 |  |
| LU |  | .290 |  | 7.37 | 5 |
| BW $_{2}$ | .125 |  | 3.18 |  |  |


| Symbol | Dimensions |  |  |  | Notes |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Inches |  | Millimeters |  |  |  |
|  | Min | Max | Min |  |  |  |
| $\mathrm{BW}_{3}$ | .030 |  | 0.76 |  |  |  |
| LS | .050 BSC |  | 1.27 |  | BSC | 6,8 |
| LT | .003 | .006 | 0.076 | 0.152 | 7 |  |
| LL | .250 | .370 | 6.35 | 9.40 |  |  |
| $\mathrm{LD}_{2}$ | .005 | .040 | 0.13 | 1.02 | 4 |  |
| $\mathrm{LO}^{2}$ | .005 |  | 0.13 |  | 9,10 |  |
| $\mathrm{LO}_{3}$ | .004 |  |  |  | 13 |  |
| $\alpha$ | $30^{\circ}$ | $90^{\circ}$ | $30^{\circ}$ | $90^{\circ}$ | 14 |  |

## NOTES:

1 Dimension are in inches.
2 Millimeters are given for general information only.
3 Index area: A notch or pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark. Alternatively, a tab (dine TL) may be used to identify pin one.
4 Dimension $\mathrm{LD}_{2}$ shall be measured at the point of exit of the lead from the body.
5 This dimension allows for off-center lid, meniscus, and glass overrun.
6 The basic pin spacing is .050 inch $(1.27 \mathrm{~mm})$ between centerlines. Each pin centerline shall be located within $\pm .005$ inch $(0.13$ mm ) of its exact longitudinal position relative to pins 1 and 14.
7 All leads: Increase maximum limit by .003 inch $(0.08 \mathrm{~mm})$ measured at the center of the flat when the lead finish is solder.
8 Twelve spaces.
9 Applies to all four corners (leads number 2, 6, 9 and 13).
10 Dimension LO may be .000 inch ( 0.00 mm if leads number $2,6,9$, and 13 ) bend toward the cavity of the package within one lead width from the point of entry of the lead into the body or if the leads are brazed to the metalized ceramic body.
11 No organic or polymeric materials shall be molded to the bottom of the package to cover the leads.
12 Optional, see note 1. If a pin one identification mark is used in addition to this tab, the minimum limit of dimension TL does not apply.
13 Applies to leads number 1, 7, 8, and 14.
14 Lead configuration is optional within dimension BW except dimensions LW and LT apply.
15 In accordance with ASME Y14.5M, diameters are eqivalent to $\phi x$ symbology.
16 Pins $1,7,8$, and 14 are collectors.
17 Pin 2, 6, 9, and 13 are bases.
18 Pin 3, 5, 10, and 12 are emitters.
19 Pins 4 and 11 are no contacts.

## FIGURE 2. Physical dimensions for type 2N6990



FIGURE 3. Schematic and terminal connections for types 2N6989 \& 2N6990

## PACKAGE DIMENSIONS



## NOTES:

1 Dimensions are in inches.
2 Millimeters are given for general information only.
3 Unless otherwise specified, tolerance is $\pm .005$ inch ( 0.13 mm ).
4 In accordance with ASME Y14.5M, diameters are equivalent to $\phi \mathrm{x}$ symbology.

| Symbol | Dimensions |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Inches |  | Millimeters |  |
|  | Min | Max | Min | Max |
| A | . 073 | . 085 | 1.85 | 2.16 |
| $\mathrm{A}_{1}$ | . 063 | . 075 | 1.60 | 1.91 |
| D | . 345 | . 355 | 8.76 | 9.02 |
| $\mathrm{D}_{1}$ | . 195 | . 205 | 4.95 | 5.21 |
| $\mathrm{D}_{2}$ | . 050 TYP |  | 1.27 TYP |  |
| $\mathrm{D}_{3}$ | . 070 | . 080 | 1.78 | 2.03 |
| E | . 025 REF |  | 0.64 REF |  |
| $\mathrm{L}_{1}$ | . 050 REF <br> for pins 2 through 20 |  | 1.27 REF <br> for pins 2 through 20 |  |
| $\mathrm{L}_{2}$ | . 080 | . 090 | 2.03 | 2.29 |

FIGURE 4. Physical demension for type 2N6989U

